

PMW3330DM-TZQU: Optical Gaming Navigation Sensor

General Description:

PMW3330DM-TZQU is PixArt Imaging's mid-range gaming sensor which comprises of navigation sensor and IR LED integrated in a 16pin molded lead-frame DIP package. It provides best in class gaming experience with the enhanced features of high speed, high resolution, high accuracy and selectable lift detection height to fulfill professional gamers' need. The sensor comes with self-adjusting variable frame rate algorithm to enable wireless gaming application. It is designed to be used with LM19-LSI lens to achieve optimum performance.

Key Features:

- Integrated 16 pin molded lead-frame DIP package with IR LED
- Operating Voltage: 1.8V 2.1V
- Lift detection options
 - o 2mm
 - o 3mm
 - o Manual Lift Cut Off Calibration
- High speed motion detection 150ips (typical) and acceleration 30g (max).
- Selectable resolutions up to 7200cpi with 50cpi step size
- Resolution error of 3% (typical)
- Four wire serial port interface (SPI)
- External interrupt output for motion detection
- Internal oscillator no clock input needed
- Self-adjusting variable frame rate for optimum power performance in wireless application
- Customizable response time and downshift time for rest modes
- Angle snapping

Applications:

- Wired and Wireless Optical gaming mice
- Integrated input devices
- Battery-powered input devices

Key Sensor Parameters:

Parameter	Value
Supply Voltage	1.8V ~ 2.1V
Interface	4 wire Serial Port Interface
	(SPI)
Tracking Speed	150ips (typical)
Acceleration	30g
CPI Resolution	Up to 7200
Frame Rate	Up to 8000 fps
Operating Current	VDD = 2.0V
	Run Avg.: 7.60mA
	Rest1: 1.20mA
	Rest2: 32uA
	Rest3: 18uA
System Clock	68MHz
Package Type	16 pin molded lead-frame
	DIP package with
	integrated IR LED
Lens Magnification	1:1

Ordering Information:

Part Number	Package Type
PMW3330DM-TZQU	16pin-DIP
LM19-LSI	Lens





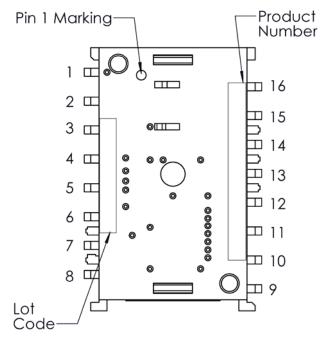
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1.0 System Level Description

This section covers PMW3330DM-TZQU's guidelines and recommendations in term of sensor, lens & PCB assemblies.

1.1 Pin Configuration



Pin No.	Function	Symbol	Туре	Description
1	NA	NC	NC	(Float)
2	NA	NC	NC	(Float)
3	Supply Voltage	VDDPIX	Power	LDO output for selective analog circuit
4	and	VDD	Power	Input power supply
5	I/O Voltage	VDDIO	Power	I/O reference voltage
6	NA	NC	NC	(Float)
7	Reset control	NRESET	Input	Chip reset(active low)
8	Ground	GND	GND	Ground
9	Motion Output	MOTION	Output	Motion detect
10		SCLK	Input	Serial data clock
11	4-wire SPI	MOSI	Input	Serial data input
12	communication	MISO	Output	Serial data output
13		NCS	Input	Chip select(active low)
14	NA	NC	NC	(Float)
15	LED	LED_P	Input	LED Anode
16	NA	NC	NC	(Float)

Figure 1. Device output pins

Table 1. PMW3330DM-TZQU Pin Description

Items	Marking	Remark		
Product	oduct PMW3330DM-TZQU			
Number				
Lot Code	AYWWXXXXX	A: Assembly house		
		Y : Year		
		WW : Week		
		XXXXX: PixArt reference		

1.2 Package Outline Drawing

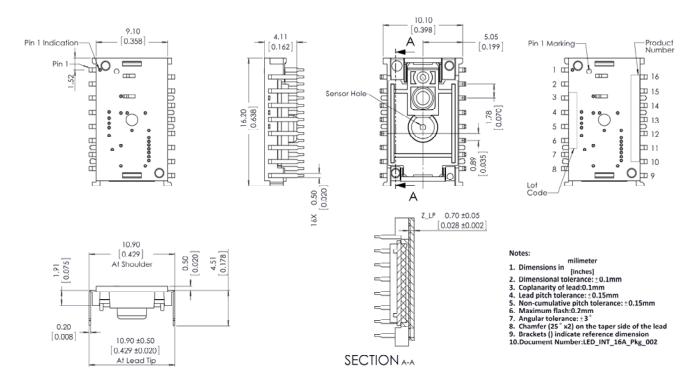


Figure 2. Packages Outline Drawing

CAUTION: It is advised that normal static discharge precautions be taken in handling and assembling of this component to prevent damage and/or degradation which may be induced by ESD.

1.3 Assembly Drawings

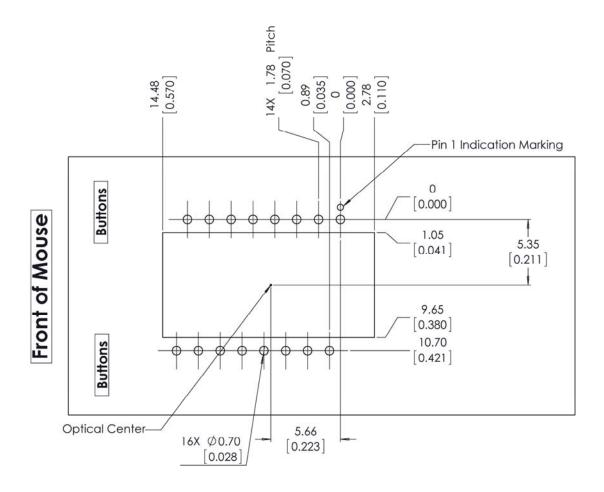


Figure 3. Recommended sensor orientation, mechanical cutouts and spacing (Top View)

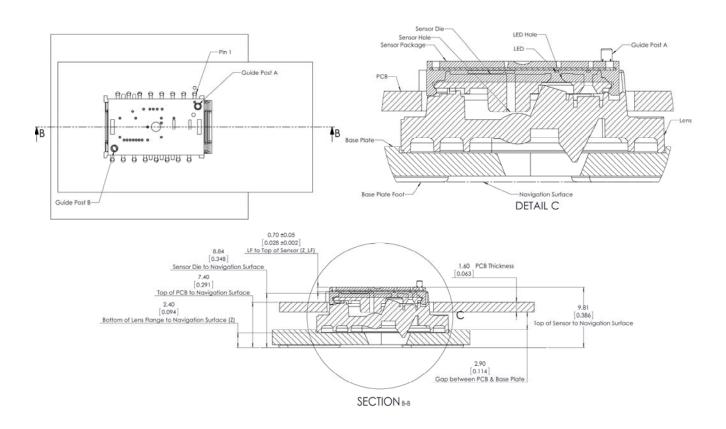


Figure 4. Assembly drawing of PMW3330DM-TZQU and distance from lens reference plane to tracking surface (Z)

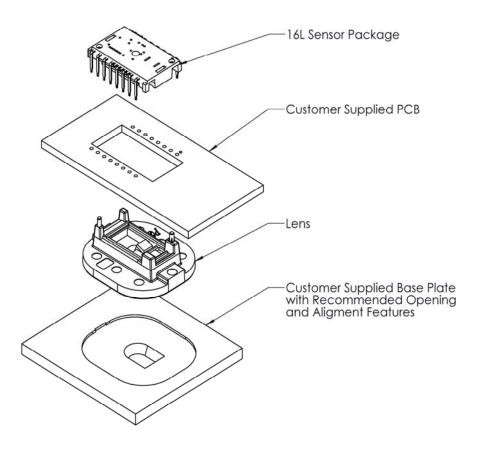


Figure 5. Exploded View of Assembly

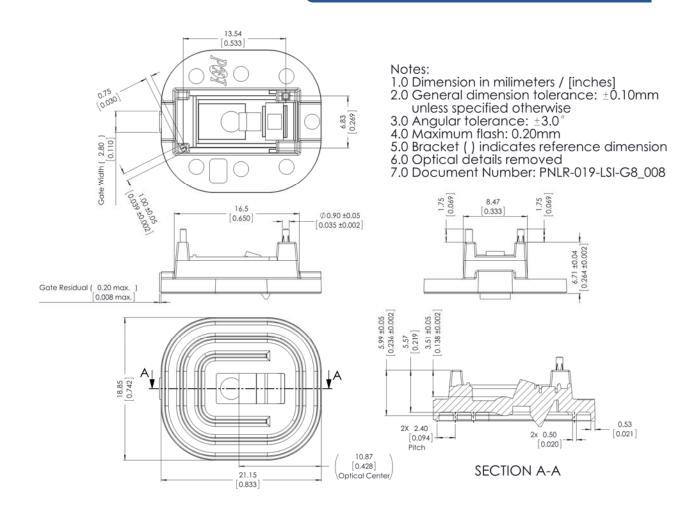
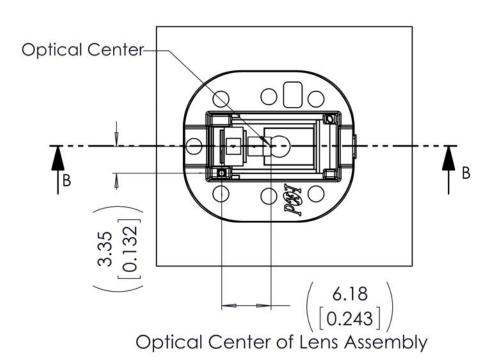


Figure 6. Lens Outline Drawing



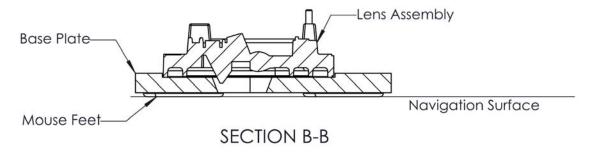


Figure 7. Cross section view of lens assembly

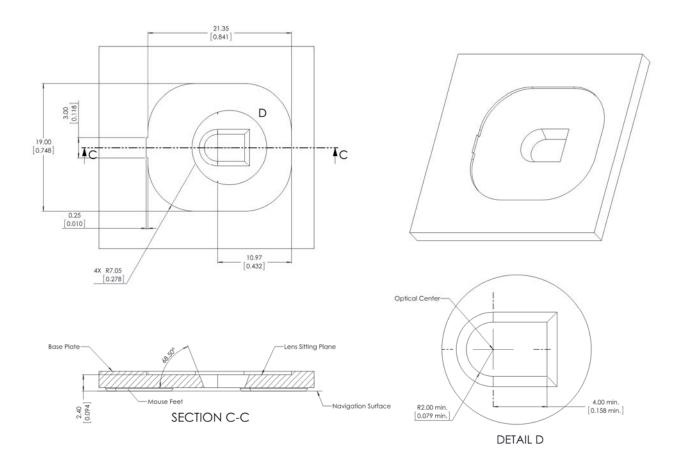


Figure 8. Recommended Base Plate Opening

Note: Mouse feet should be placed close to the opening to stabilize the surface within the FOV of the sensor.

1.4 PCB Assembly Recommendation

- 1) Insert the integrated sensor and all other electrical components into PCB.
- 2) Wave-solder the entire assembly in a no-wash solder process utilizing solder-fixture. A solder-fixture is required to protect the sensor from flux spray and wave solder.
- 3) Avoid getting any solder flux onto the sensor body as there is potential for flux to seep into the sensor package, the solder fixture should be designed to expose only the sensor leads to flux spray & molten solder while shielding the sensor body and optical apertures. The fixture should also set the sensor at the correct position and height on the PCB.
- 4) Place the lens onto the base plate. Care must be taken to avoid contamination on the optical surfaces.
- 5) Remove the protective kapton tapes from optical apertures of the sensor. Care must be taken to prevent Contaminants from entering the apertures. Do not place the PCB with the sensor facing up during the entire mouse assembly process. Hold the PCB vertically when removing kapton tape.
- 6) Insert PCB assembly over the lens onto the base plate aligning post to retain PCB assembly. The sensor package will self-align to the lens via the guide posts. The optical position reference for the PCB is set by the base plate and lens. Note that the PCB motion due to button presses must be minimized to maintain optical alignment.
- 7) **Recommendation**: The lens can be permanently secured to the sensor package by melting the lens' guide posts over the sensor with heat staking process.
- 8) Install mouse top case. There must be a feature in the top case to press down onto the PCB assembly to ensure all components are stacked or interlocked to the correct vertical height.

Sensor Block Diagram

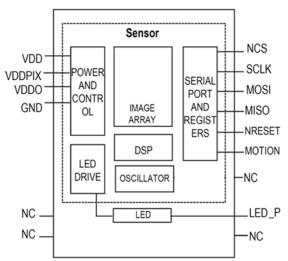


Figure 9. Block diagram of PMW3330DM-TZQU

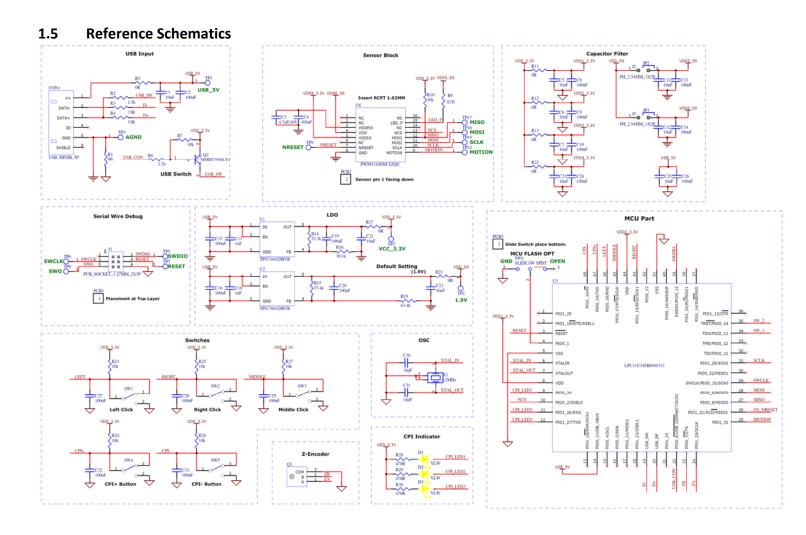


Figure 10. Schematic diagram for interface between PMW3330DM-TZQU and microcontroller on a wired solution

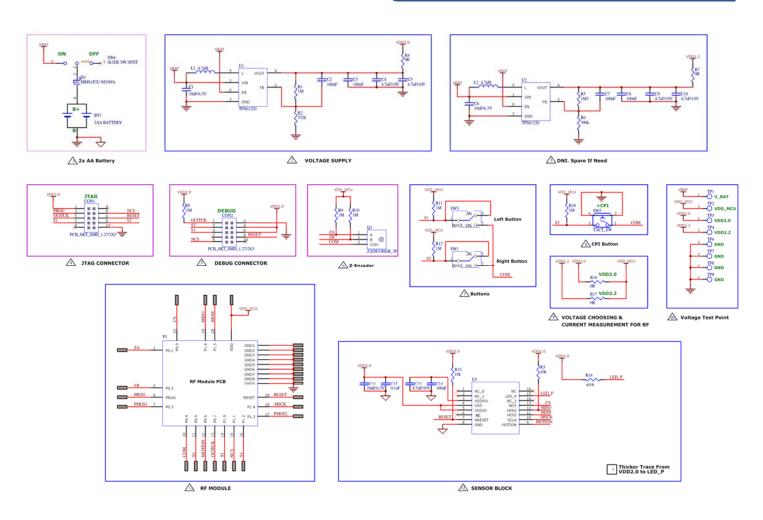


Figure 11. Schematic diagram for interface between PMW3330DM-TZQU and microcontroller in a wireless solution

2.0 Electrical Specifications

Regulatory Requirements

- Passes FCC "Part15, Subpart B, Class B", "CISPR 22 1997 Class B" and worldwide analogous emission limits when assembled into a mouse with shielded cable and following PixArt Imaging's recommendations.
- Passes IEC 62471: 2006 Photo biological safety of lamps and lamp systems

2.1 Absolute Maximum Ratings

Table 2: Absolute Maximum Ratings

Parameter	Symbol	Minimum	Maximum	Units	Notes
Storage Temperature	Ts	-40	85	°C	
Lead Solder Temperature	T _{SOLDER}		260	°C	For 7 seconds, 1.6mm below seating plane.
Supply Voltage	V_{DD}	-0.5	2.10	V	
	V _{DDIO}	-0.5	3.60	V	
ESD (Human Body Model)			2	kV	All pins
Input Voltage	V _{IN}	-0.5	3.6	V	All I/O pins.

2.2 Recommended Operating Conditions

Table 3: Recommended Operating Condition

Parameter	Symbol	Min	Тур.	Max	Units	Notes
Operating Temperature	T _A	0		40	°C	
Power Supply Voltage	V_{DD}	1.80	2.0	2.10	V	excluding supply noise
	V _{DDIO}	1.80	2.0	3.60	V	excluding supply noise. (VDDIO must be same or greater than VDD)
Power Supply Rise Time	t _{RT}	0.15		20	ms	0 to VDD min
Supply Noise (Sinusoidal)	V_{NA}			100	mVp-p	10 kHz —75 MHz
Serial Port Clock Frequency	f _{SCLK}			2.25	MHz	50% duty cycle
Distance from Lens Reference Plane to Tracking Surface	Z	2.2	2.4	2.6	mm	
Speed	S		150		ips	220ips on QCK, Vespula Speed, Vespula Control and FUNC 1030 surfaces
Resolution error	R _{esErr}		3		%	Up to 150ips on QCK with 3000 cpi
Acceleration	А			30	g	In run mode

2.3 AC Electrical Specifications

Table 4. AC Electrical Specifications

Electrical characteristics, over recommended operating conditions. Typical values at 25 °C, V_{DD} = 2.0 V, V_{DDIO} = 2.0 V.

Parameter	Symbol	Minimum	Typical	Maximum	Units	Notes
Motion Delay After Reset	t _{MOT-RST}	50			ms	From reset to valid motion, assuming motion is present
Shutdown	t _{STDWN}			500	μs	From Shutdown mode active to low current
Wake From Shutdown	twakeup	50			ms	From Shutdown mode inactive to valid motion. Notes: A RESET must be asserted after a shutdown. Refer to section "Notes on Shutdown", also note t _{MOT-RST}
MISO Rise Time	t _{r-MISO}		50		ns	C _L = 100pF
MISO Fall Time	t _{f-MISO}		50		ns	C _L = 100pF
MISO Delay After SCLK	t _{DLY-MISO}			90	ns	From SCLK falling edge to MISO data valid, no load conditions
MISO Hold Time	t _{hold-MISO}	200			ns	Data held until next falling SCLK edge
MOSI Hold Time	t _{hold-MOSI}	200			ns	Amount of time data is valid after SCLK rising edge
MOSI Setup Time	t _{setup-MOSI}	120			ns	From data valid to SCLK rising edge
SPI Time Between Write Commands	t _{sww}	45			μs	From rising SCLK for last bit of the first data byte, to rising SCLK for last bit of the second data byte.
SPI Time Between Write And Read Commands	t _{swr}	45			μs	From rising SCLK for last bit of the first data byte, to rising SCLK for last bit of the second address byte.
SPI Time Between Read And Subsequent Commands	t _{SRW} t _{SRR}	20			μs	From rising SCLK for last bit of the first data byte, to falling SCLK for the first bit of the address byte of the next command.
SPI Read Address-Data Delay	t _{SRAD}	35			μs	From rising SCLK for last bit of the address byte, to falling SCLK for first bit of data being read.
NCS Inactive After Motion Burst	t _{BEXIT}	500			ns	Minimum NCS inactive time after motion burst before next SPI usage
NCS To SCLK Active	t _{NCS-SCLK}	120			ns	From last NCS falling edge to first SCLK rising edge
SCLK To NCS Inactive (For Read Operation)	t _{SCLK-NCS}	120			ns	From last SCLK rising edge to NCS rising edge, for valid MISO data transfer
SCLK To NCS Inactive (For Write Operation)	t _{SCLK-NCS}	35			μs	From last SCLK rising edge to NCS rising edge, for valid MOSI data transfer

Parameter	Symbol	Minimum	Typical	Maximum	Units	Notes
NCS To MISO High-Z	t _{NCS-MISO}			500	ns	From NCS rising edge to MISO high-Z state
MOTION Rise Time	t _{r-MOTION}		50		ns	C _L = 100pF
MOTION Fall Time	t _{f-MOTION}		50		ns	C _L = 100pF
Input Capacitance	C _{in}		50		рF	SCLK, MOSI, NCS
Load Capacitance	C _L			100	pF	MISO, MOTION
Transient Supply Current	I _{DDT}			70	mA	Max supply current during the supply ramp from 0V to V _{DD} with min 150 us and max 20ms rise time. (Does not include charging currents for bypass capacitors)
	I _{DDTIO}			60	mA	Max supply current during the supply ramp from 0V to V _{DDIO} with min 150 us and max 20ms rise time. (Does not include charging currents for bypass capacitors)

2.4 DC Electrical Specifications

Table 5. DC Electrical Specifications

Electrical characteristics, over recommended operating conditions. Typical values at 25 °C, V_{DD} = 2.0 V, V_{DDIO} = 2.0 V

Parameter	Symbol	Min	Typical	Max	Units	Notes
DC Supply Current	I _{DD_RUN_VFR1} [4k FPS]		7.0		mA	
	I _{DD_RUN_VFR2} [8k FPS]		12.8		mA	Average current, including LED
						current at 1ms motion polling on Qck surface
	I _{DD_REST1}		1.2		mA	QCK Surface
	I _{DD_REST2}		32		uA	
	I _{DD_REST3}		18		uA	
Power Down Current	I _{PD}		3		μΑ	
Input Low Voltage	V _{IL}			0.3 x V _{DDIO}	V	SCLK, MOSI, NCS
Input High Voltage	V _{IH}	0.7 x V _{DDIO}			V	SCLK, MOSI, NCS
Input Hysteresis	V _{I_HYS}		100		mV	SCLK, MOSI, NCS
Input Leakage Current	I _{leak}		±1	±10	μΑ	Vin=V _{DDIO} or OV, SCLK, MOSI, NCS
Output Low Voltage	V _{OL}			0.45	>	lout=1mA, MISO, MOTION
Output High Voltage	V _{OH}	V _{DDIO} - 0.45			V	lout=-1mA, MISO, MOTION

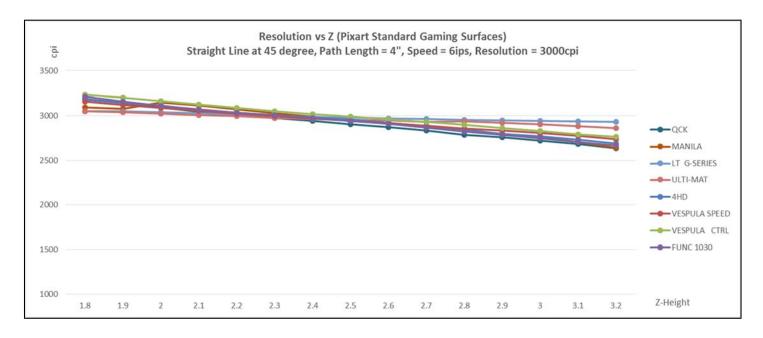


Figure 12. Mean Resolution vs. Z at default resolution at 3000cpi

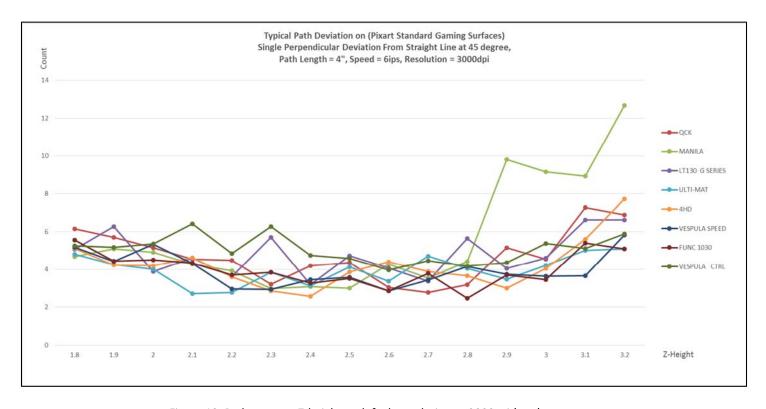


Figure 13. Path error vs. Z-height at default resolution at 3000cpi (mm)

3.0 Serial Peripheral Interface (SPI)

The synchronous serial port is used to set and read parameters in PMW3330DM-TZQU sensor, and to read out the motion information.

The port is a four wire port. The host microcontroller always initiates communication; PMW3330DM-TZQU sensor never initiates data transfers. SCLK, MOSI, and NCS may be driven directly by a microcontroller. The port pins may be shared with other SPI slave devices. When the NCS pin is high, the inputs are ignored and the output is tri-stated.

The lines that comprise the SPI port are:

SCLK	Clock input, generated by the master (microcontroller).
MOSI	Input data. (Master Out/Slave In)
MISO	Output data. (Master In/Slave Out)
NCS	Chip select input (active low). NCS needs to be low to activate the serial port; otherwise, MISO will be high Z, and MOSI & SCLK will be ignored. NCS can also be used to reset the serial port in case of an error.

Motion Pin Timing

The motion pin is an active low output that signals the micro-controller when motion has occurred. The motion pin is lowered whenever the motion bit is set; in other words, whenever there is non-zero data in the Delta_X_L, Delta_X_H, Delta_Y_L or Delta_Y_H registers. Clearing the motion bit (by reading MOTION registers) will put the motion pin high.

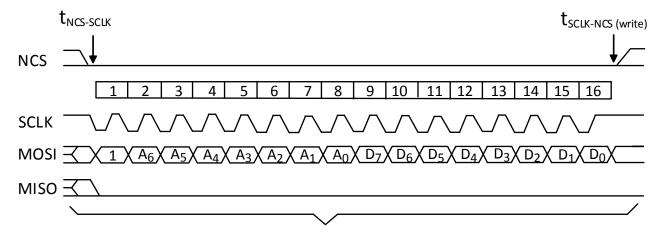
Chip Select Operation

The serial port is activated after NCS goes low. If NCS is raised during a transaction, the entire transaction is aborted and the serial port will be reset. After a transaction is aborted, the normal address-to-data or transaction-to-transaction delay is still required before beginning the next transaction. To improve communication reliability, all serial transactions should be framed by NCS. In other words, the port should not remain enabled during periods of non-use because ESD and EFT/B events could be interpreted as serial communication and put the chip into an unknown state. In addition, NCS must be raised after each burst-mode transaction is complete to terminate burst-mode. The port is not available for further use until burst-mode is terminated.

SEE. FEEL. TOUCH.

Write Operation

Write operation, defined as data going from the micro-controller to PMW3330DM-TZQU sensor, is always initiated by the micro-controller and consists of two bytes. The first byte contains the address (seven bits) and has a "1" as its MSB to indicate data direction. The second byte contains the data. PMW3330DM-TZQU sensor reads MOSI on rising edges of SCLK.



MOSI Driven by Micro-Controller Figure 14. Write operation

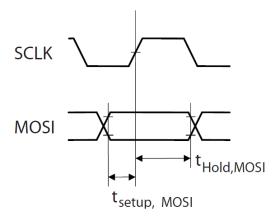
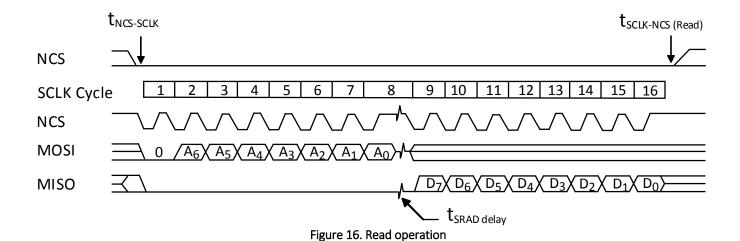


Figure 15. MOSI setup and hold time

Read Operation

A read operation, defined as data going from PMW3330DM-TZQU sensor to the micro-controller, is always initiated by the micro-controller and consists of two bytes. The first byte contains the address, is sent by the micro-controller over MOSI, and has a "0" as its MSB to indicate data direction. The second byte contains the data and is driven by PMW3330DM-TZQU sensor over MISO. The sensor outputs MISO bits on falling edges of SCLK and samples MOSI bits on every rising edge of SCLK.



SCLK

t_{DLY-MISO}

MISO

D₀

Figure 17. MISO Delay and hold time

Note: The minimum high state of SCLK is also the minimum MISO data hold time of PMW3330DM-TZQU sensor. Since the falling edge of SCLK is actually the start of the next read or write command, PMW3330DM-TZQU sensor will hold the state of data on MISO until the falling edge of SCLK.

SEE. FEEL. TOUCH.

Required timing between Read and Write Commands (tsxx)

There are minimum timing requirements between read and write commands on the serial port.

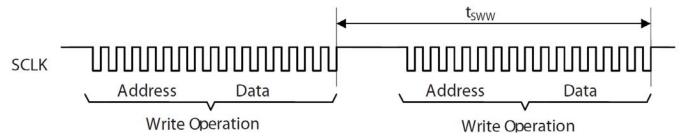


Figure 18. Timing between two write commands

If the rising edge of the SCLK for the last data bit of the second write command occurs before the t_{SWW} delay, then the first write command may not complete correctly.

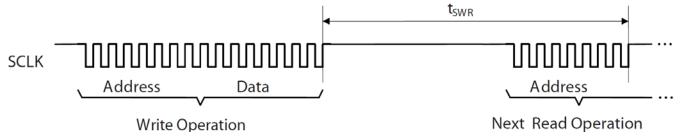


Figure 19. Timing between write and either write or subsequent read commands

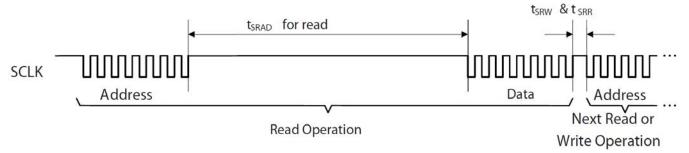


Figure 20. Timing between read and either write or subsequent read commands

If the rising edge of SCLK for the last address bit of the read command occurs before the t_{SWR} required delay, the write command may not complete correctly. During a read operation SCLK should be delayed at least t_{SRAD} after the last address data bit to ensure that the Sensor has time to prepare the requested data.

The falling edge of SCLK for the first address bit of either the read or write command must be at least t_{SRR} or t_{SRW} after the last SCLK rising edge of the last data bit of the previous read operation. In addition, during a read operation SCLK should be delayed after the last address data bit to ensure that PMW3330DM-TZQU sensor has time to prepare the requested data.

SEE. FEEL. TOUCH.

4.0 Burst mode operation

Burst Mode Operation

Burst mode is a special serial port operation mode which may be used to reduce the serial transaction time for motion read. The speed improvement is achieved by continuous data clocking to or from multiple registers without the need to specify the register address, and by not requiring the normal delay period between data bytes.

Motion Read

Reading the Burst_Motion_Read register activates this mode. PMW3330DM-TZQU sensor will respond with the following motion burst report in order. Motion burst report:

BYTE[00] = Motion

BYTE[01] = Observation

BYTE[02] = Delta X L

BYTE[03] = Delta_X_H

BYTE[04] = Delta Y L

BYTE[05] = Delta_Y_H

BYTE[06] = SQUAL

BYTE[07] = Pixel_Sum

BYTE[08] = Maximum_Pixel

BYTE[09] = Minimum_Pixel

BYTE[10] = Shutter_Upper

BYTE[11] = Shutter_Lower

After sending the register address, the microcontroller must wait for t_{SRAD} , and then begin reading data. All data bits can be read with no delay between bytes by driving SCLK at the normal rate. The data are latched into the output buffer after the last address bit is received. After the burst transmission is complete, the microcontroller must raise the NCS line for at least t_{BEXIT} to terminate burst mode. The serial port is not available for use until it is reset with NCS, even for a second burst transmission.

Procedure to start motion burst:

- 1. Lower NCS signal, wait for tNCS-SCLK delay.
- 2. Send Burst_Motion_Read address (0x16).
- 3. Wait for t_{SRAD}
- 4. Start reading SPI Data continuously up to 12 bytes. Motion burst may be terminated by pulling NCS high for at least talent.
- 5. To read new motion burst data, repeat from step 1.

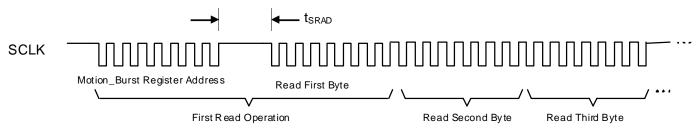


Figure 21. Motion Read sequence

Note: Motion burst data can be read from the Burst Motion Read registers even in run or rest mode.

SEE. FEEL. TOUCH.

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5.0 Power Up

Although the sensor performs an internal power up self reset, it is still recommend that the Power_Up_Reset register is written every time power is applied. The appropriate sequence is as follows:

- 1. Apply power to VDD and VDDIO in any order, with a delay of no more than 100ms in between each supply. Ensure all supplies are stable.
- 2. Drive NCS high, and then low to reset the SPI port.
- 3. Write 0x5A to Power_Up_Reset register (or, alternatively toggle the NRESET pin).
- 4. Wait for at least 50ms.
- 5. Read from registers 0x02, 0x03, 0x04, 0x05 and 0x06 one time regardless of the motion pin state.
- 6. Load power up initialization register setting.
 - Write 0x80 to register 0x78
 - Write 0x80 to register 0x79
 - Write 0x80 to register 0x14
 - Write 0x40 to register 0x20
 - Write 0x40 to register 0x1A
 - Write 0x90 to register 0x1D
 - Write 0x12 to register 0x62
 - Write 0x12 to register 0x63
 - Write 0x02 to register 0x7f
 - Write 0x01 to register 0x40
 - Write 0x00 to register 0x7f

During power-up there will be a period of time after the power supply is high but before normal operation. The table below shows the state of the various pins during power-up and reset.

State of Signal Pins After VDD is Valid							
Pin	During Reset	After Reset					
NRESET	Functional	Functional					
NCS	Ignored	Functional					
MISO	Undefined	Depends on NCS					
SCLK	Ignored	Depends on NCS					
MOSI	Ignored	Depends on NCS					
MOTION	Undefined	Functional					

NRESET

The NRESET pin can be used to perform a full chip reset. When asserted, it performs the same reset function as the Power_Up_Reset_Register. The NRESET pin needs to be asserted (held to logic 0) for at least 100 ns.

Note:- NRESET pin has a built in weak pull up circuit. During active low reset phase, it can draw a static current of up to 600uA.

6.0 Shutdown

PMW3330DM-TZQU can be set in Shutdown mode by writing to Shutdown register. The SPI port should not be accessed when Shutdown mode is asserted, except the power-up command (writing 0x5a to register 0x3a). Other ICs on the same SPI bus can be accessed, as long as the sensor's NCS pin is not asserted.

To de-assert Shutdown mode:

- 1. Drive NCS high, and then low to reset the SPI port.
- 2. Write 0x5A to Power Up Reset register (or, alternatively toggle the NRESET pin).
- 3. Wait for at least 50ms.
- 4. Read from registers 0x02, 0x03, 0x04, 0x05 and 0x06 one time regardless of the motion pin state.
- 5. Load power up initialization register setting.
 - Write 0x80 to register 0x78
 - Write 0x80 to register 0x79
 - Write 0x80 to register 0x14
 - Write 0x40 to register 0x20
 - Write 0x40 to register 0x1A
 - Write 0x90 to register 0x1D
 - Write 0x12 to register 0x62
 - Write 0x12 to register 0x63
 - Write 0x02 to register 0x7f
 - Write 0x01 to register 0x40
 - Write 0x00 to register 0x7f

Pin	Status when Shutdown Mode
NRESET	High
NCS	High*1
MISO	Hi-Z*2
SCLK	Ignore if NCS = 1*3
MOSI	Ignore if NCS = 1*4
MOTION	Output High

- *1. NCS pin must be held to 1 (high) if SPI bus is shared with other devices. It is recommended to hold to 1 (high) during Shutdown unless powering up the Sensor. It must be held to 0 (low) if the sensor is to be re-powered up from shutdown (writing 0x5a to register 0x3a).
- *2. MISO should be either pull up or down during shutdown in order to meet the low power consumption specification in the Data sheet.
- *3. SCLK is ignored if NCS is 1 (high). It is functional if NCS is 0 (low).
- *4. MOSI is ignored if NCS is 1 (high). If NCS is 0 (low), any command present on the MOSI pin will be ignored except power-up command (writing 0x5a to register 0x3a).

Note:- There is long wakeup time from shutdown. These features should not be used for power management during normal mouse motion.

7.0 Lift Detection Options

There are three lift detection options for this sensor:-

- o 2mm (default setting)
- o 3mm
- o Manual Lift Cut Off calibration

For application which required to have a lift detection that is lower than 2mm, manual lift cut off calibration procedure need to be implemented in the micro controller side. Please refer to section 7.3 for the manual lift cut off calibration for the complete implementation details.

7.1 General 2mm Lift Cut Off Setting

Setting for 2 mm lift detection: -

- 1) Write register 0x60 with value 0x04.
- 2) Write Register 0x69 with value 0x06.

7.2 General 3mm Lift Cut Off Setting

Setting for 3 mm lift detection: -

- 1) Write register 0x60 with value 0x0C.
- 2) Write register 0x69 with value 0x10.

7.3 Manual Lift Cut Off Calibration

This sensor has the ability to optimize its lift performance by calibrate internal parameters to the tracking surface. This lift cut off calibration feature involves user interaction.

- 1. To ensure that the lift cut off calibration procedure starts from a known configuration, reset the sensor and apply the recommended "Power Up" sequence.
- 2. Set up the following registers:
- a) Write 0x80 to register Config (register 0x40).
- b) Write 0x03 to register Resolution (register 0x1b).
- c) Write 0x47 to register 0x5C.
- 3. Prompt the user that the lift cut off calibration procedure is about to begin to ensure that the mouse is placed on the surface (mouse is not lifted).
- 4. The lift cut off calibration procedure can be triggered by a GUI prompt to the user or user-initiated through a mouse-click event. Once the procedure is triggered, write 0x91 to register LiftCutOff_Calibration_Control (register 0x22). Read register bit LiftCutOff_Calibration_Status (register 0x23) bit [2] = 0 to confirm that the sensor is in lift cut off calibration mode.
- 5. The external MCU is responsible for tracking accumulated distance, duration and speed during lift cut off calibration motion.

- a) The recommended minimum accumulated distance is 20 inches.
- b) The recommended maximum duration is 20 seconds.
- c) The recommended minimum and maximum mouse speed is 1 and 10 ips respectively.
- 6. If either 5a or 5b is satisfied, stop the lift cut off calibration procedure by writing 0x10 to register
 LiftCutOff_Calibration_Control (register 0x22). Read register bit LiftCutOff_Calibration_Status (register 0x23) bit [2] =
 1 to confirm that the sensor is out of lift cut off calibration mode. The user should then be prompted that the lift cut
 off calibration procedure has stopped. The procedure is valid if all of the following are true:
- a) Accumulated distance is more than the recommended value in step 5a.
- b) Duration is less than the recommended value in step 5b.
- c) Mouse speed during the procedure is within the recommended values in step 5c.

If the procedure is invalid, either re-start the procedure from step 3 or exit lift cut off calibration by proceeding to step 8.

If the procedure is valid, proceed to read register bit LiftCutOff_Calibration_Status (register 0x23) bit [0]:

- a) If LiftCutOff_Calibration_Status (register 0x23) bit [0] = 1, the sensor is able to calibrate to the surface. Proceed to step 7.
- b) If LiftCutOff_Calibration_Status (register 0x23) bit [0] = 0, the sensor is unable to calibrate to the surface. Proceed to step 8.
- 7. Proceeding from this step means that the sensor is able to recommend a new set of "Min SQUAL Run" and SQUAL threshold values. Update the sensor settings with the recommended values through these steps:
- a) Read register LCC_Msq (register 0x70) and write the read back value to register 0x4e.
- b) Read register LCC_Sqth (register 0x71) and write the read back value to register 0x57.

Complete lift cut off calibration by writing to the following registers:

- a) Write 0x04 to register address 0x41.
- b) Write 0x0C to register address 0x42.
- c) Write 0x44 to register address 0x5C.
- d) Write 0x64 to register address 0x5E.
- e) Write 0x81 to register address 0x35.
- f) Write 0x00 to register Config (register 0x40).
- g) Write desired resolution setting to the register Resolution (register 0x1b).

Proceed to step 9.

- 8. Proceeding from this step means the sensor is unable to calibrate the surface. Write to the following registers to exit from lift cut off calibration:
- a) Write 0x40 to register 0x5c.
- b) Write 0x00 to Config (register 0x40).
- c) Write desired resolution setting to Resolution (0x1b).

Proceed to step 9.

9. The lift cut off calibration procedure is completed.

8.0 Registers Table

PMW3330DM-TZQU registers are accessible via the serial port. The registers are used to read motion data and status as well as to set the device configuration.

Address	Register	Access: R = Read, W = Write, Read / Write= RW	Default Value
0x00	Product_ID	R	0x45
0x02	Motion	RW	0x00
0x03	Delta_X_L	R	0x00
0x04	Delta_X_H	R	0x00
0x05	Delta_Y_L	R	0x00
0x06	Delta_Y_H	R	0x00
0x07	SQUAL	R	0x00
0x08	Pixel_Sum	R	0x00
0x09	Maximum_Pixel	R	0x00
0x0A	Minimum_Pixel	R	0x00
0x0B	Shutter_Lower	R	0x12
0x0C	Shutter_Upper	R	0x00
0x15	Chip_Observation	RW	0x80
0x16	Burst_Motion_Read	R	0x00
0x19	Pix_Grab_Status	R	0x00
0x1B	Resolution	RW	0x3B
0x1E	Angle_Snap	RW	0x04
0x20	Axis_Control	RW	0x00
0x22	LiftCutoff_Calibration_Control	RW	0x10
0x23	LiftCutoff_Calibration_Status	RO	0x00
0x24	Run_DownShift	RW	0x08
0x25	Rest1_Period	RW	0x01
0x26	Rest1_Downshift	RW	0x4F
0x27	Rest2_Period	RW	0x19
0x28	Rest2_Downshift	RW	0x5E
0x29	Rest3_Period	RW	0x3F
0x32	Pix_Grab	RW	0x00
0x3A	Power_Up_Reset	W	N/A
0x3B	Shutdown	W	N/A
0x3F	Inv_Product_ID	R	OxBA
0x40	Config	RW	0x00
0x4E	Min_Squal_Run_LCC_Paf	RW	0x0F
0x70	LCC_Msq	RO	0x00
0x71	LCC_Sqth	RO	0x00

9.0 Registers Description

Register: 0x00								
Name: Product_ID								
Bit #	7	6	5	4	3	2	1	0
Field	PID ₇	PID ₆	PID ₅	PID ₄	PID ₃	PID ₂	PID ₁	PID ₀
Reset Value				0x ²	15			
Access				Read	Only			
Data Type				8-bit unsign	ed integer			
Usage		•		assigned to y that the ser		•		_

Register: 0x02												
Name: Motion												
Bit #	7	6	5	4	3	2	1	0				
Field	MOT	Reserved	Reserved	Reserved	Reserved	Reserved	OP_MODE ₁	OP_MODE ₀				
Reset Value	0x00											
Access	Read / Write											
Data Type		8-bit Field										
	read. The production Delta_Y_1. Read Delta_Y_2. If the read in t Delta_Y_ second t	cedure to re _H) is as follo the Motion _H register w MOT bit is s the given sec _L and Delta time, the da	ad the moti ows: register. Thi ralues. et, Delta_X_ quence to go _Y_H registo ta in Delta_X	on registers s will freeze L, Delta_X_let the accumers are not r K_L, Delta_X	(Delta_X_L, the Delta_X H, Delta_Y_L nulated moti ead before t _H, Delta_Y_	Delta_X_H, _L, Delta_X . and Delta_ on. Note: it .he motion _L and Delt	Delta_Y_L a _H, Delta_Y_ _Y_H registe f Delta_X_L, register is re a_Y_H will b	_L and rs should be Delta_X_H, ead for the				
	Field N	ame Des	cription									
	MOT Motion since last report or PD O = No motion 1 = Motion occurred, data ready for reading in Delta_X_L, Delta_X_H, Delta_Y_L and Delta_Y_H registers											
	OP_Mo [1:0] Write ar	01 - 10 - 11 -	- Run mode - Rest 1 - Rest 2 - Rest 3	will clear all	motion data							

Register: 0x03									
Name: Delta_X_L									
Bit #	7	6	5	4	1	3	2	1	0
Field	X ₇	X ₆	X ₅	X	4	X ₃	X ₂	X ₁	X ₀
Reset Value					0	x00			
Access					Rea	d Only			
Data Type		1	16 bits 2's	complem	ent nur	nber. Lov	ver 8 bits of [Delta_X.	
	X movemo	ent is cou -32768	ınts since l - 32767	ast report -2	Absol -1	ute value 0	is determine +1 +2	ed by resolut + 3276 6	ion. 5 + 32767
Usage	Delta_X	8000	8001	FFFE	FFFF	00	01 02	7FFE	7FFF

Register: 0x04								
Name: Delta_X_H								
Bit #	7	6	5	4	3	2	1	0
Field	X ₁₅	X ₁₄	X ₁₃	X ₁₂	X ₁₁	X ₁₀	X ₉	X ₈
Reset Value				0x0	00			
Access				Read	Only			
Data Type		16 bit	s 2's comp	lement numl	oer. Upper 8	3 bits of Delt	a_X.	
Usage	Delta_X_H m	nust be rea	d after Delt	a_X_L to hav	e the full m	otion data.		

Register: 0x05								
Name: Delta_Y_L								
Bit #	7	6	5	4	3	2	1	0
Field	Y ₇	Y ₆	Y ₅	Y ₄	Y ₃	Y ₂	Y ₁	Y ₀
Reset Value				0x0	00			
Access				Read	Only			
Data Type		16 b	its 2's comp	lement numl	oer. Lower	8 bits of Delt	a_Y.	
	Y movement	t is counts	since last re	port. Absolut	e value is c	letermined b	y resolution	
Usage	Motion Delta_Y	<u> </u>	8001	-2 -1	0 +	1 +2	+32766 	+32767 ———————————————————————————————————

Register: 0x06								
Name: Delta_Y_H								
Bit #	7	6	5	4	3	2	1	0
Field	Y ₁₅	Y ₁₄	Y ₁₃	Y ₁₂	Y ₁₁	Y ₁₀	Y ₉	Y ₈
Reset Value					0x00			
Access				Re	ad Only			
Data Type		16	bits 2's com	plement n	umber. Upp	er 8 bits of D	elta_Y.	
Usage Delta_Y_H must be read after Delta_Y_L to have the full motion data.								
Note: It is recommended that register 0x02, 0x03, 0x04, 0x05 and 0x06 to be read sequentially.								

Register: 0x07											
Name: SQUAL											
Bit #	7	6	5	4	3	2	1	0			
Field	SQ ₇	SQ_6	SQ ₅	SQ ₄	SQ₃	SQ_2	SQ_1	SQ ₀			
Reset Value	0x00										
Access	Read Only										
Data Type	8-bit unsigned integer										
Usage	the sensor features. Number of The maxim result in ch graph belo slowly over	Features = Jum SQUAL anges in SC w shows 5 white pap	ent frame. SQUAL Reg register va QUAL, variat SOO sequen er.	Use the foll gister Value alue is 0x9c cions in SQL tially acqui	* 4 :. Since sma JAL when lo	all changes in oking at a suvery while	valid feature the total num on the current urface are exp le a sensor v measuring SO	frame can bected. The was moved			

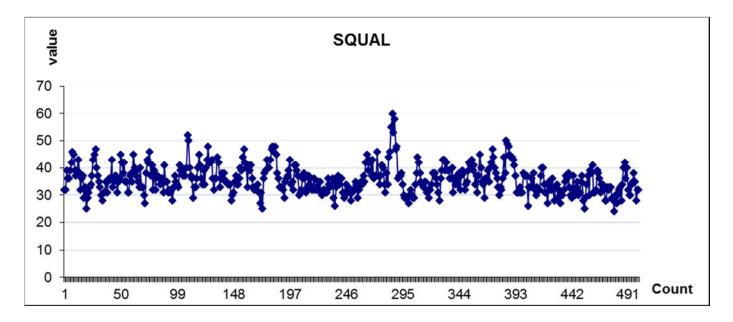


Figure 22. Average SQUAL on white paper

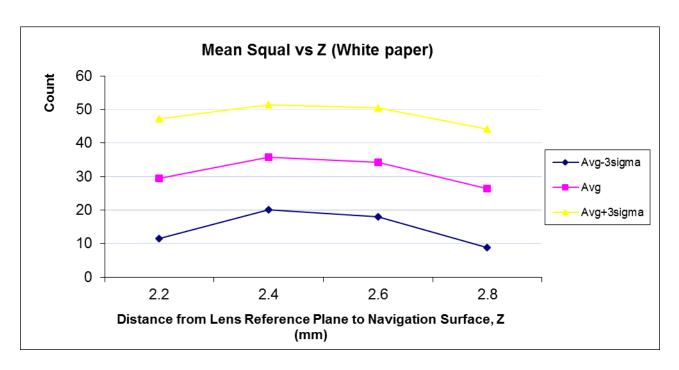


Figure 23. Mean Squal vs Z

Register: 0x08								
Name: Pixel_Sum								
Bit #	7	6	5	4	3	2	1	0
Field	AP ₇	AP ₆	AP ₅	AP ₄	AP ₃	AP ₂	AP_1	AP ₀
Reset Value					0x00			
Access				Re	ad Only			
Data Type				8-bit uns	igned intege	r		
Usage	counter wh	nich sums a um registe	ll 784 pixels	s in the curr	el value. It rent frame. inimum regis before readir	ster value i	s 0. The pixe	

Register: 0x09								
Name: Maximum_Pixel								
Bit #	7	6	5	4	3	2	1	0
Field	MP ₇	MP ₆	MP ₅	MP ₄	MP ₃	MP ₂	MP ₁	MP ₀
Reset Value				(0x00			
Access				Rea	nd Only			
Data Type				8-bit unsi	gned intege	r		
Usage				frame. Mi e every frame		e = 0, maxir	num value =	: 127. The

Register: 0x0A								
Name: Minimum_Pixel								
Bit #	7	6	5	4	3	2	1	0
Field	MinP ₇	MinP ₆	MinP ₅	MinP ₄	MinP ₃	MinP ₂	MinP ₁	MinP ₀
Reset Value				C)x00			
Access				Rea	d Only			
Data Type				8-bit unsi	gned intege	r		
Usage				frame. Min		e = 0, maxir	num value =	127. The

Register: 0x0B									
Name: Shutter_Lower									
Bit #	7	6	5	4	3	2	1	0	
Field	S ₇	S ₆	S ₅	S 4	S ₃	S 2	S ₁	So	
Reset Value				(0x12				
Access				Rea	ad Only				
Data Type	12-bit unsigned number								
Usage	Lower byte of the 12-bit Shutter register.								

Register: 0x0C											
Name: Shutter_Upper											
Bit #	7	6	5	4	3	2	1	0			
Field	Reserved	Reserved	Reserved	S ₁₂	S ₁₁	S ₁₀	S ₉	S ₈			
Reset Value		0x00									
Access		Read Only									
Data Type		12-bit unsigned number									
Usage	Upper 4-bit of the 12-bit Shutter register. Units are clock cycles of the internal oscillator. Read Shutter_Upper first, then Shutter_Lower. They should be read consecutively. The shutter is adjusted to keep the average pixel values within normal operating ranges. The shutter value is checked and automatically adjusted to a new value if needed on every frame when operating in default mode.										

Register: 0x15											
Name: Chip_Observation											
Bit #	7	6	5	4	3	2	1	0			
Field	Reserved Reserved CO ₅ CO ₄ CO ₃ CO ₂ CO ₁ CO ₀										
Reset Value	0x80										
Access	Read / Write										
Data Type	Bit Field										
Usage	the registe may be use event. T _{dly_obs} is de sensor is ir	er. The actived as part of the control of the contr	e process (of recovery e longest fi de. Clock fr	CO ₅₋₀ will have scheme to contain the contains and period equency toles.	ve set the co detect a prob +0.5ms. The erance value	rresponding olem caused e longest fra e need to be	T_{dly_obs} ms & labit. The regist by EFT/B or Embedding me period is staken into accept (500 x 1.4)	eter ESD when count.			

Register: 0x16												
Name: Burst_Motion_Read												
Bit #	7	7 6 5 4 3 2 1 0										
Field	MB ₇	MB ₆	MB ₅	MB ₄	MB ₃	MB_2	MB_1	MB ₀				
Reset Value	0x00											
Access		Read										
Data Type		Bit Field										
Usage	The Burst_Motion_Read register is used for high-speed access to the Motion, Observation, Delta_X_L, Delta_X_H, Delta_Y_L, Delta_Y_H, SQUAL, Pixel_Sum, Maximum_Pixel, Minimum_Pixel, Shutter_Upper and Shutter_Lower registers. See Burst Mode-Motion Read section for use details.											

Register: 0x19											
Name: Pix_Grab_Status											
Bit #	7	6	5	4	3	2	1	0			
Field	Reserved	eserved PG_VALID PG_FIRST Reserved Reserved Reserved Reserved Reserved									
Reset Value		0x00									
Access	Read										
Data Type				Bi	t Field						
	This regist	er provide a	additional i	nformation 1	for user to m	nonitor the s	ensor naviga	tion status.			
	Field Nan	ne Desc	ription								
Usage	PG_VALII) 1 = F	ixel Grab v	alid							
	PG_FIRST	1 = F	ixel Grab fi	rst							
								_			

Register: 0x1B											
Name: Resolution											
Bit #	7	6	5	4	3	2	1	0			
Field	RES 7 RES 6 RES 5 RES 4 RES 3 RES 2 RES 1 RES 0										
Reset Value	0x3B										
Access	Read / Write										
Data Type	8-bit unsigned integer										
	register setting can be calculated using the following formula. Each bit change is ~50cpi. The recommended maximum write value is 0x8f, which the resolution setting is approximately 7200cpi.										
Usage	Field Name Description RES 7-0 Set resolution with CPI step of approximately 50 cpi 0x00: 50 cpi (minimum) 0x01: 100 cpi : 0x3b: 3000 cpi : 0x8f: 7200 cpi										

Register: 0x1e										
Name: Angle_Snap										
Bit #	7	6	5	4	3	2	1	0		
Field	EN	0	0	0	0	1	0	0		
Reset Value	0x04									
Access	Read /Write									
Data Type				8-bit uns	igned intege	r				
	Write to th	nis register	to enable t	he angle sna	ap feature.					
	Field Name Description									
Usage	EN 0: angle snap disable 1: angle snap enable									

Register: 0x20											
Name: Axis_Control											
Bit #	7	6	5	4	3	2	1	0			
Field	Swap_XY	wap_XY INV_Y INV_X Reserved Reserved									
Reset Value		0x00									
Access	Read /Write										
Data Type	Bit Field										
	This registe	er set the a	xis directio	n of the sen	sor reporting	5.					
	Field Nam	ne Desc	ription								
Heada	Swap_XY	1: Sv	vap XY dire	ctions							
Usage	INV_Y	INV_Y 1: Invert Y direction									
	INV_X	INV_X 1: Invert X direction									
								_			

Register: 0x22										
Name: LiftCutoff_Calibration_Control										
Bit #	7	6	5	4	3	2	1		0	
Field	LCCCLK_EN	Reserved	0	1	Reserved	Reserved	Reserved	LCC_	_START	
Reset Value	0x10									
Access				Read /Wri	te					
Data Type	Bit Field									
	This register is to configure the lift cutoff calibration settings									
	Field Name Description									
Usage	Lift cut off calibration procedure enable LCCCLK_EN 0: Disable 1: Enable									
ладс	LCC_START	Lift c 0: St o 1: Sta	ор	ion Start/Stop						

Register: 0x23											
Name: LiftCutoff_Calibration_Status											
Bit #	7	6	5	4	3	2	1	0			
Field	Reserved	Reserved Reserved Reserved Reserved LCC_DONE Reserved LCC_VALI									
Reset Value		0x00									
Access		Read Only									
Data Type	Bit Field										
	This register	provide th	e lift cutoff ca	alibration sta	atus						
	Field Name	Desci	ription								
Heada	LCC_DONE	Lift c	ut off calibrat	ion done							
Usage	LCC_VALID		t off calibration I nvalid	n Result							
		0x1: \	Valid								

Register: 0x24												
Name: Run_Downsh	ift											
Bit #	7	6	5	4	3	2	1	0				
Field	0	0 0 RD ₅ RD ₄ RD ₃ RD ₂ RD ₁ RD ₀										
Reset Value		0x08										
Access		Read / Write										
Data Type		8-bit unsigned integer										
Usage	Run Down Example fo Max Dowr	shift time (or 4k FPS = nshift time	ms) = RD[7 8 x 256 x 0 s 63 x 256 :	:0] x 256 x V .25 = 512ms x 0.25 = 403	FR1		elow for calcu	ılation.				
	All the abo	ove values a	are expecte	d to have a -	+40% & -20%	% tolerance.						

Register: 0x25												
Name: Rest1_Period												
Bit #	7	6	5	4	3	2	1	0				
Field	R1P ₇	R1P ₇ R1 P ₆ R1 P ₅ R1 P ₄ R1 P ₃ R1 P ₂ R1 P ₁ R1 P ₀										
Reset Value	0x01											
Access	Read / Write											
Data Type	8-bit unsigned integer											
Usage	Rest1 perio Default res Min value		0] x 1ms = 1 x 1ms = value of 0x0		+40% & -20%	% tolerance.						

Register: 0x26												
Name: Rest1_Downshift												
Bit #	7	6	5	4	3	2	1	0				
Field	R1D ₇	R1D ₇ R1D ₆ R1D ₅ R1D ₄ R1D ₃ R1D ₂ R1D ₁ R1D ₀										
Reset Value	0x4F											
Access	Read / Write											
Data Type	8-bit unsigned integer											
Usage	Rest1 Dow Default = 7 Min value	nshift time 79 x 256 x 1 is 0x01. A v	(ms) = R1E ms = 2022 value of 0x0)[7:0] x 256 :	x rest1_perion	od(default =: ed to 0x01.	below for cal	culation.				

Register: 0x27											
Name: Rest2_Period											
Bit #	7	6	5	4	3	2	1	0			
Field	R2P ₇	R2P ₇ R2P ₆ R2P ₅ R2P ₄ R2P ₃ R2P ₂ R2P ₁ R2P ₀									
Reset Value	0x19										
Access	Read / Write										
Data Type				8-bit uns	igned intege	er					
Usage	Rest2 peri Default res Min value	od = R2P[7 st2 period : is 0x01. A \	= 25 x 1ms: value of 0x0	:lock (1ms) x		% tolerance.					

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Register: 0x28												
Name: Rest2_Downshift												
Bit #	7	6	5	4	3	2	1	0				
Field	R2D ₇	R2D ₆	R2D ₅	R2D ₄	R2D ₃	R2D ₂	R2D ₁	R2D ₀				
Reset Value	0x5E											
Access		Read / Write										
Data Type		8-bit unsigned integer										
Usage	Rest2 Dow Default = 9 Min value	nshift time 94 x 64 x 10 is 0x01. A v	(ms) = R20 00ms = 601 value of 0x0		rest2_perio ernally clipp	d(default =1 ed to 0x01.	below for cal	culation.				

Register: 0x29										
Name: Rest3_Period										
Bit #	7	6	5	4	3	2	1	0		
Field	R3P ₇ R3P ₆ R3P ₅ R3P ₄ R3P ₃ R3P ₂ R3P ₁ R3P ₀									
Reset Value	0x3F									
Access	Read / Write									
Data Type	8-bit unsigned integer									
Usage	This register Rest3 period Default rest Min value is All the abov	d = R3P[7:0 3 period = 0 0x01. A va	33 x 1ms x8 1ue of 0x00	= 504ms is invalid.	3 40% & -20%	tolerance.				

Register: 0x32												
Name: Pix_Grab												
Bit #	7	6	5	4	3	2	1	0				
Field	VALID	VALID PIX 6 PIX 5 PIX 4 PIX 3 PIX 2 PIX 1 PIX 0										
Reset Value	0x00											
Access	Read / Write											
Data Type		8-bit unsigned integer										
Usage	 Write re Write at Continut Read re form a 500us) error, at Write re 	egister 0x6k ny value to ously read gister 0x32 complete p delay betw nd pix grab	for the 1 b fixel array i een each r	0x80 32 19 until gett it VALID flag nformation eadout. An eds to repe	cing both PG g and 7 bit Al with at leas y readout da at from step	DC data (PI) t 1 frame p ata with VA	(6–0) for 784 eriod (recor	1 times to nmended				

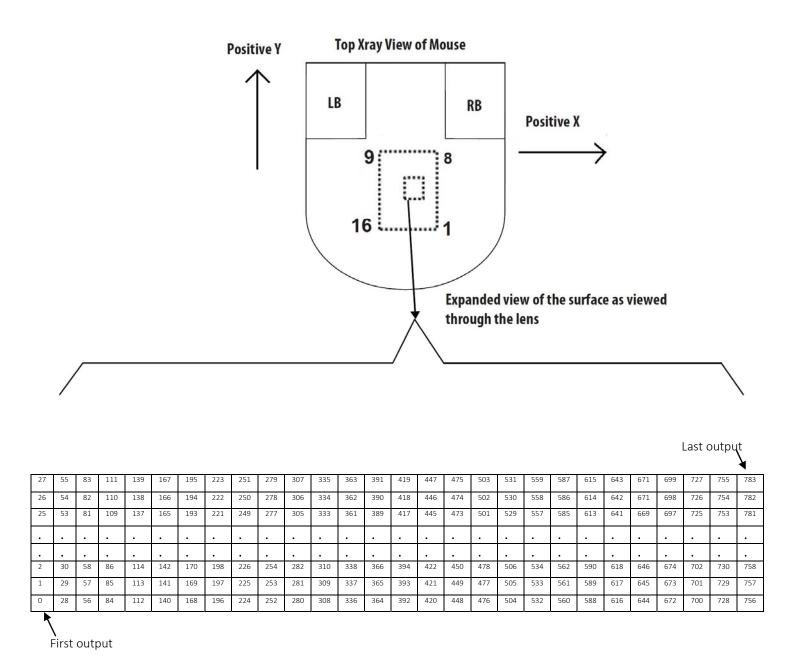


Figure 24. Pixel Map (Surface referenced)

Note: The X/Y reporting direction is showed above which is follow all the power up initialization in Power Up section.

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Register: 0x3A											
Name: Power_Up_Reset											
Bit #	7	6	5	4	3	2	1	0			
Field	PUR ₇	PUR ₆	PUR ₅	PUR ₄	PUR ₃	PUR ₂	PUR ₁	PUR ₀			
Reset Value	N/A										
Access				Wri	ite Only						
Data Type				8-bit uns	igned intege	r					
Usage Write 0x5a to this register to reset the chip. All settings will revert to default values. Reset is required after recovering from shutdown mode.											

Register: 0x3B											
Name: Shutdown											
Bit #	7	6	5	4	3	2	1	0			
Field	SD ₇	SD ₆	SD ₅	SD ₄	SD ₃	SD ₂	SD_1	SD ₀			
Reset Value				N	I/A						
Access				Writ	e Only						
Data Type	8-bit unsigned integer										
Usage	Write 0xB6 details on i		•	tdown mode	. Refer to tl	he Shutdown	section for r	more			

Register: 0x3F													
Name: Inverse_Product_ID													
Bit # 7 6 5 4 3 2 1 0													
Field	IPID ₇	IPID ₇ IPID ₆ IPID ₅ IPID ₄ IPID ₃ IPID ₂ IPID ₁ IPID ₀											
Reset Value				0	xВА								
Access				Read	d Only								
Data Type		Bit Field											
Usage	This value i	s the inver	se of the Pr	oduct_ID. It i	s used to te	est the SPI po	rt hardware.						

Register: 0x40										
Name: Config										
Bit #	7	6	5	4	3	2	1	0		
Field	AWAKE	0	0	0	0	0	0	0		
Reset Value	0x00									
Access	Read / Write									
Data Type				Bit	Field					
	This register of	configures	the operat	ing mode o	f the senso	r				
	Field Name	Descri	ption							
Usage	AWAKE 0: Enable rest mode 1: Disable rest mode, sensor always in active mode									

Register: 0x4E												
Name: Min_Squal_Run_LiftCutoff_Calibration												
Bit # 7 6 5 4 3 2 1 0												
Field	MSRST ₇	MSRST ₇ MSRST ₆ MSRST ₅ MSRST ₄ MSRST ₃ MSRST ₂ MSRST ₁ MSRST ₀										
Reset Value	0x0f											
Access				Read	/ Write							
Data Type				8-bit unsig	ned intege	r						
Usage	This register set the min number of feature to navigate											

Register: 0x70	Register: 0x70												
Name: LiftCutoff_Calibration_Min_Squal_Threshold													
Bit# 7 6 5 4 3 2 1 0													
Field	STMST ₇	MST ₇ STMST ₆ STMST ₅ STMST ₄ STMST ₃ STMST ₂ STMST ₁ STMST ₀											
Reset Value				Ox	x00								
Access				Read	/Write								
Data Type		8-bit unsigned integer											
Usage			ft cut off o SQUAL Run		rocedure, t	his register _l	provides lift	cut off					

Register: 0x71								
Name: LiftCutoff_Calibration_Squal_Threshold								
Bit #	7	6	5	4	3	2	1	0
Field	STST ₇	STST ₆	STST ₅	STST ₄	STST₃	STST ₂	STST ₁	STST ₀
Reset Value	0x00							
Access	Read /Write							
Data Type	8-bit unsigned integer							
Usage	After a successful lift cut off calibration procedure, this register provides lift cut off calibration Minimum SQUAL threshold							